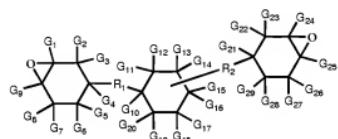


## AMENDMENTS TO THE CLAIMS

The claims in this listing will replace all prior versions, and listings, of claims in the application.

### Listing of Claims:

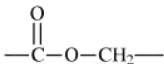
1. (Currently Amended) A method process of enhancing the toughness of a coating on an article, said coating comprising a cured cycloaliphatic epoxy resin, said method comprising the steps of using (a) applying a curable coating composition to the article; wherein the composition comprises an as the epoxy resin a compound of the formula:



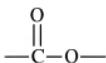
wherein R<sub>1</sub> and R<sub>2</sub> are divalent organic moieties that may be the same or different; wherein each of G<sub>1</sub>-G<sub>29</sub> are independently hydrogen, phenyl, or substituted or unsubstituted alkyl or alkene moieties having from 1 to about 10 carbon atoms; and wherein the composition comprises from about 25 wt% to 100 wt% of the cycloaliphatic epoxy resin; and (b) curing the curable coating composition.

2. (Withdrawn) The method of Claim 1 wherein the cycloaliphatic epoxy resin comprises the reaction product of from about 40 to about 95 weight percent of a cycloaliphatic epoxide carboxylic acid ester and from about 5 to about 60 weight percent of the hydroxy functional compound.

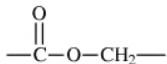
3. (Original) The process of Claim 1 wherein R<sub>1</sub> is



4. (Withdrawn) The process of Claim 1 wherein R<sub>1</sub> is

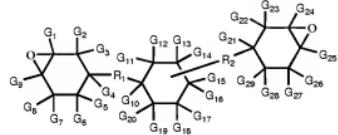


5. (Currently Amended) The process cycloaliphatic epoxy resin of Claim 1 wherein R<sub>1</sub> and R<sub>2</sub> are each



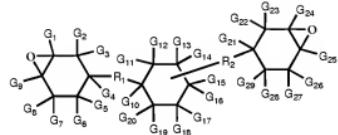
6. (Currently Amended) The process cycloaliphatic epoxy resin of Claim 1 wherein each of G<sub>1-29</sub> are hydrogen.

7. (Withdrawn) A photocurable composition comprising an effective amount of a photoinitiator, and an epoxy resin of the following formula:



wherein R<sub>1</sub> and R<sub>2</sub> are divalent organic moieties that may be the same or different.

8. (Withdrawn) A thermally-curable composition comprising an effective amount of a thermally-activated initiator, and an epoxy resin of the following formula:



wherein R<sub>1</sub> and R<sub>2</sub> are divalent organic moieties that may be the same or different.

9. (Withdrawn) The composition of Claim 8 that is an LED encapsulant formulation.